



HyperX Cloud III S Wireless - Gaming Headset (Black-Red) (A59Z0AA)

Overview

A Legend Evolved.



The Cloud III S Wireless represents the next evolution of Cloud III Wireless, retaining all the beloved features of its predecessor. In addition to the 2.4GHz wireless connectivity, users can connect to more devices via Bluetooth or an Instant Pair² mode that is compatible with select OMEN laptops. It also boasts extended battery life and multiple customization options. With HyperX signature comfort, this headset delivers luxurious comfort for all-day gaming or marathon streaming sessions. With up to 120 hours¹ of battery life, you can enjoy hours of uninterrupted gaming fun via 2.4GHz. Push the limits even further with up to 200 hours in Bluetooth mode. Equipped with 53mm angled drivers, it delivers crystal-clear sound and enhanced audio positioning, precisely identifying critical audio cues like footsteps. The 10mm microphone provides clear communication with teammates, crisp call quality, and effortless conversations with friends. With easy-to-use audio controls, you can swiftly mute or unmute the microphone, adjust volume levels, and switch between wireless modes effortlessly. Whether you're gaming, listening to music, watching YouTube, browsing Twitch, or completing assignments, the Cloud III S Wireless ensures you never miss a beat or crucial shot!

Up to 120 Hours^[1] of Gaming on a Single Charge

Achieve up to 120 hours of gameplay on 2.4GHz. Push the limits even further with up to 200 hours in Bluetooth Mode^[1].

Audio Tuned for Your Entertainment

Angled 53 mm drivers have been tuned by HyperX audio engineers to provide an optimized listening experience that accents the dynamic sounds of gaming.

Connect via 2.4GHz, Bluetooth, or Instant Pair^[2]

Gain the convenience and versatility of wireless freedom with 2.4GHz wireless or Bluetooth connectivity. Instant Pair^[2] is also available with select OMEN gaming laptops, no dongle required.

HyperX Signature Comfort

Comfort is in the Cloud III's DNA. HyperX signature memory foam in the headband and ear cushions wrapped in soft, premium leatherette make for a plush, comfortable fit all around.

[1] Tested at 50% headphone volume, continuous playback. Actual battery life will vary with use and maximum battery capacity will naturally decrease with time and usage.

[2] Instant Pair is available only on select OMEN laptop models. Connecting multiple devices via Instant Pair will affect individual device performance. See the product support page for details.

Specifications

Form Factor	Over-ear; Circumaural; Closed back
Product Dimensions W x D x H (metric)	11.5 x 21 x 22.3 cm
Product Dimensions W x D x H (imperial)	4.52 x 8.26 x 8.77 in
Weight (metric)	Headset: 340 g; USB wireless dongle: 4.3 g; Boom mic: 12 g
Weight (imperial)	Headset: .79 lb; USB wireless dongle: .0094 lb; Boom mic: .026 lb
Package Dimensions W x D x H (metric)	11.5 x 21 x 22.3 cm
Package Weight (metric)	737 g
Battery Life	2.4GHz Wireless USB: Up to 120 hours
UPC Number	198415435569
Manufacturer Warranty	2 years
What Is In The Box	Wireless Gaming Headset, Detachable Microphone, Wireless Dongle, USB-C to USB-A Adapter, USB Charge Cable, Quick Start Guide

Additional specifications

Audio Connection	2.4 GHz Wireless USB; Bluetooth
Audio Controls	Volume, multifunction button, mic mute / mic monitoring
Bit-Depth	24/16-bit playback; 16-bit microphone
Bluetooth Version	5.3
Boom Mic Element	Electret condenser microphone
Boom Mic Frequency Response	100 Hz to 10 kHz
Boom Mic Polar Pattern	Uni-directional
Boom Mic Sensitivity	- 42 dB at 1 kHz
Built-In Mic Element	MEMS
Built-In Mic Frequency Response	100 Hz to 10 kHz
Built-In Mic Polar Pattern	Omni-directional
Built-In Mic Sensitivity	- 40 dB at 1 kHz
Cable Length (imperial)	0.54 yd
Cable Length (metric)	0.5 m
Cable Type	USB-C to USB-C
Charge Time	5 hours
Color	Red
Compatibility Statement	PC; Mac; PS5; Mobile; Switch. Software Compatibility: NGENUITY
Connection Type	Wireless
Connectivity	Wireless
Datasheet Photo 01	https://hp.widen.net/content/ehbgpefiak/png/HyperX_Cloud_III_S_Wireless_Red_A59Z0AA_main_1_3471510.png
Datasheet Photo 02	https://hp.widen.net/content/7dot8hvwHP/png/HyperX_Cloud_III_S_Wireless_Red_A59Z0AA_angle_3_3471332.png
Datasheet Photo 03	https://hp.widen.net/content/puzmhcvxip/png/HyperX_Cloud_III_S_Wireless_Red_A59Z0AA_angle_6_3471333.png
Datasheet Photo 05	Publication logos/HyperX_header_bydefault.png
Depth (imperial)	0.73 ft
Depth (metric)	223 mm

Driver	Dynamic, 53 mm with neodymium magnets
Driver Type	Dynamic, 53 mm
Ear Cushions	Memory foam (padding material); Premium leatherette (surface material)
Element	Electret condenser microphone
Frame Type	Stainless steel; aluminum forks
Frequency Response (Headphone)	20 Hz to 20 kHz
Handle	hyperx-cloud-III-S-wireless-gaming-headset
Height (imperial)	8.34 in
Height (metric)	21.2 cm
Impedance	64 Ω
KSP 09 Supporting Point 01 (long)	Personalize your headset with removable magnetic earcup plates to match your unique setup. Sold separately and available in select countries/regions.
Length (imperial)	8.74 in
Length (metric)	22.2 cm
Microphone Type	Boom microphone; Built-in (on ear)
Package Dimensions W x D x H (imperial)	4.52 x 8.26 x 8.77 in
Package Weight (imperial)	1.62 lb
Polar Pattern	Omnidirectional
Published	draft
Sampling Rates	96/48 kHz playback; 48/16 kHz microphone
Sensitivity (Headphone)	111.94 $\pm$ 3 dB SPL at 1kHz (1mW)
Status	FALSE
Supported Bluetooth Codecs	SBC; MPEG-2; AAC-LC
Supported Bluetooth Profiles	A2DP; AVCTP; AVDTP; AVRCP; DID; GAVDP; HFP; HID; HSP; PBAP; RFCOMM; SPP; DIS
Total Harmonic Distortion	< 2%
UNSPSC Code	52161514
USB Audio Format	Stereo playback; mono microphone
USB Specification	USB 2.0

Width (imperial)	4.44 in
Width (metric)	11.3 cm
Wireless Range	Up to 20 m
Wireless Type	2.4 GHz; Bluetooth®

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